# SIEMENS

TV-Stereo-Sound

TDA 6612-2

Preliminary Data

Bipolar IC

Features

The TDA 6612-2 represents a complete TV-stereo system controlled by the I^2C Bus according to German TV-Stereo standard.

- All functions inclusive matrix adjustment are I^2C Bus controlled
- Inputs for AM sound or NICAM
- SCART-interface
- Independent headphones
- Universal clock generation circuit build-in
- Clipping detector build-in
- Volume control
- High signal-to-noise ratio
- Extremely low total harmonic distortions
- High security for the detection of the identification signals because of the digital interference suppression and the very narrow bandwidth
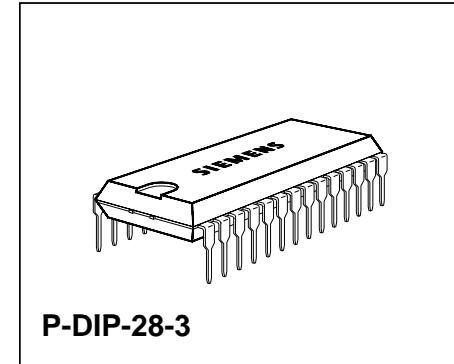
P-DIP-28-3
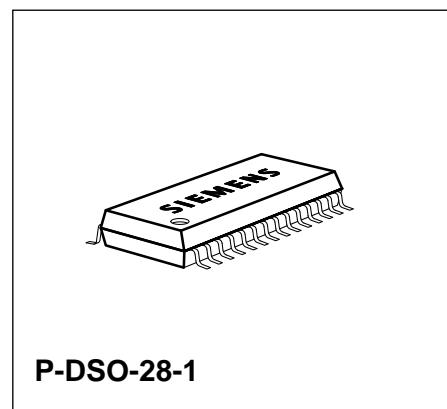
P-DSO-28-1

Type	Ordering Code	Package
TDA 6612-2	Q67000-A5097	P-DIP-28-3
TDA 6612-2X	Q67000-A5194	P-DSO-28-1

The IC is divided into three functional blocks

1 Stereo Sound Processing with High Performance (exceeds DIN 45500; suitable for NICAM and CD)

a) Matrix for G-standard with crosstalk compensation controlled via the I²C Bus

b) Additional single channel AF input (for e.g. AF signal according to L-standard)

c) Stereo SCART interface according to FTZ-official specification

d) Stereo loudspeaker signal section with Ch1/Ch2 switch, bass/treble control, quasi stereo/stereo base width expansion and separate loudspeaker volume control for left and right (balance)

e) Separate stereo head phone signal section with Ch1/Ch2 switch and volume control

2 TV-Sound Identification Signal Decoder Consisting of:

a) Active pilot signal filter

b) Phase independent rectifier with very narrow bandwidth for evaluation of the identification signal

c) Digital integrator to reduce interferences by noise

d) Multiplexer for cyclical switch over between "stereo" or "dual" evaluation

e) Reference signal generation with externally synchronized PLL

- synchronization with external H-sync pulse or 62.5-kHz clock

- build-in crystal oscillator and external 4-MHz crystal

- external 4-MHz (or 1-MHz) clock signal

3 Control Section for:

a) I²C Bus interface with listen/talk function

b) Control of the complete AF-sound signal detector

c) Read access to the clipping detector

d) Control of the identification signal decoder

e) Reading of the status of the identification signal decoder

f) Test modes

Circuit Description

Signal Section

The audio signal processing in the matrix and the switch-over for multi channel TV-sound signals according to the two carrier system used in Germany takes place in the matrix and switching sections. Crosstalk compensation is carried out in the sound 1 input stage. The crosstalk compensation range has an adjustment range of ± 3 dB with a step width of 0.2 dB. In addition to the two inputs for the demodulated sound carrier a two channel SCART-input and an additional mono input (e.g. for demodulated L-standard sound) are provided. The two AF (pin 1 and pin 2) inputs can be by-passed internally in such a way that decoded stereo sound of other audio systems (NICAM) can be processed. The switching section includes also the SCART-output with the possibility to select the sound 1 or 2 during the "dual" mode. The Ch1/Ch2-switches for the loudspeaker and headphone outputs are independently switchable.

In the signal path for the volume control unit output there is the Ch1/Ch2-switch followed by two different volume control units. The first has a control range from 0 to – 15 dB with a step width of 1.25 dB. In conjunction with the main volume control after bass and treble control a high immunity against overdriving the output stage is reached. The first volume control is used as a "pre-stage" of the main volume control in conjuntion with the clipping detector. This section is followed by a switchable quasi stereo stage which provides a stereophonic audio effect with mono signals due to a 180° phase shift at medium frequencies (about 1 kHz) in one channel. The following bass control has a control range of +15/–12 dB with a step width of 3 dB. The cut-off frequency for each channel is set with an external capacitor. The implemented switchable circuit for stereo base width expansion provides a three dimensional aural reception. This is realized with a 50% frequency dependent crosstalk with opposite phase of the signal between both channels. The circuit operates with the same cut-off frequency as the bass control, but the function is widely independent. The treble control has a step width of 3 dB with an control range of +/–12 dB. The cut-off frequency of the treble control is derived from one capacitor for each channel. The loudspeaker signal path is terminated with the loudspeaker control, independently adjustable for left and right. With 57 steps of 1.25 dB the adjustment range is 70 dB, where step 57 activates the "MUTE" function. Functions such as "balance" or "loudness" are realized by software and adjustment of the appropriate tone and volume controls. In the volume control unit there is a clipping detector. The status of the clipping detector can be evaluated via the I^2C Bus. Therefore it is possible to implement an automatic volume control using the clipping detector and software implemented into the controller.

After every evaluation the clipping bit is reset. Therefore after a read access to the clipping bit a new evaluation of the clipping detector status is possible.

The signal path for the headphones contains a volume control after the Ch1/Ch2-switch with a common adjustment for left and right. Thirty two steps of 2 dB give an adjustment range of 62 dB (31 x 2 dB = 62 dB, the 32nd step is MUTE).

Identification Signal Decoder

The input of the identification signal decoder consists of an op-amp for the pilot signal with its side bands. An external LC-circuit is used. The signal is then passed to a phase independent active band-pass filter with a very narrow bandwidth (adjustable externally). This filter detects whether the lower side band of the pilot carrier, which is modulated with the identification signal, is present. The

center frequency of the filter is switched between "dual" and "stereo" by a multiplexer. The multiplexing frequency is adjustable by software. If a side band is detected, the multiplexer stops. The interferences on the first "detected" criterion are suppressed by a digital integrator with a following comparator and can be read out via I²C Bus (talk mode) as the "stereo" or "dual" mode. The control of the corresponding signal can be either directly internally or through the μC. All the necessary clock signal are derived from a fast setting PLL which is synchronized by a reference frequency. This reference frequency must be sufficiently close to the horizontal frequency, but a **rigid phase coupling is not required**. Therefore, alternatively the use of a crystal controlled 62.5-kHz frequency commonly found in PLL-tuning systems is possible. A further alternative for the clock signal generation is a build-in crystal oscillator with an external 4-MHz crystal or the use an external 1- or 4-MHz clock frequency.

Control Section

All functions are controlled via an I²C Bus interface with "listen" / "talk" functions. The data bytes currently used are stored in a block of latches.

The telegram structure is formed in the following manner:

start condition - chip address - any number of bytes - stop condition

The following conditions apply to the data bytes:

Before the actual data byte (with the adjustment information), **always** an I²C Bus sub-address byte has to be transmitted. The I²C Bus interface however is interpreting this sub-address byte as a data byte.

Example: The headphone volume is to be increased in a number of steps.

Right	Wrong
Start condition	Start condition
Chip address 84 (Hex)	Chip address 84 (Hex)
Sub-addr. vol. HP 03 (Hex)	Sub-addr. vol. HP 03 (Hex)
Vol. step 8 08 (Hex)	Vol. step 8 08 (Hex)
Sub-addr. vol. HP 03 (Hex)	Vol. step 9 09 (Hex)
Vol. step 9 09 (Hex)	Vol. step 10 0A (Hex)
Sub-addr. vol. HP 03 (Hex)	Stop condition
Vol. step 10 0A (Hex)	
Stop condition	

Within a telegram (i.e. without a new start condition) any different sub-addresses can be accessed. The changeover between "listen" and "talk" access to the IC however must always occur using the following sequence: stop condition - start condition - chip address. Before each read access always a start condition and chip address (talk) must be transmitted. The data to be read out are then loaded into the I²C Bus interface and can be transferred to the μC.

Chip Address

MSB	•	•	•	•	•	•	LSB
1	0	0	0	0	1	0	R/W

R/W = 0 $\rightarrow$ Read (Listen)
R/W = 1 $\rightarrow$ Write (Talk)

Subaddress Bytes

	MSB •	•	•	•	•	•	•	LSB
Volume input control	X	X	X	X	X	1	0	0
Volume of left speaker	X	X	X	X	X	0	0	1
Volume of right speaker	X	X	X	X	X	0	1	0
Volume of headphones	X	X	X	X	X	0	1	1
Treble / bass	X	X	X	X	X	1	0	1
Switch byte I	X	X	X	X	X	1	1	1
Switch byte II	X	X	X	X	X	0	0	0
Crosstalk adjustment	X	X	X	X	X	1	1	0

Control Bytes
a) Volume Input Control

	MSB	•	•	•	•	•	•	LSB
Maximum volume	Qu-H	Ch1/Ch2$_{EN}$	Ch1/Ch2$_{SC}$	0	0	0	0	MUTE III
Max – 1	Qu-H	Ch1/Ch2$_{EN}$	Ch1/Ch2$_{SC}$	0	0	0	1	MUTE III
Min + 1	Qu-H	Ch1/Ch2$_{EN}$	Ch1/Ch2$_{SC}$	1	0	1	1	MUTE III
Minimum volume	Qu-H	Ch1/Ch2$_{EN}$	Ch1/Ch2$_{SC}$	1	1	0	0	MUTE III
Power ON	0	0	0	0	0	0	0	1

Qu-H = 0   PLL synchronization with H-pulse; power ON

Qu-H = 1   PLL synchronization with crystal oszillator,

additionally the bit "H-pulse" has to be set to "H" in switch byte II

Ch1/Ch2EN	Ch1/Ch2SC	SCART output	SCART output
		pin 9	pin 10
0	0	sound 1	sound 2
0	1	sound 2	sound 1
1	0	sound 1	sound 1
1	1	sound 2	sound 2

Ch1/Ch2EN, Ch1/Ch2SC are only activated if the matrix is in the dual mode

(switch byte ll: matrix 0 = 1 and matrix 1 = 0 or matrix 0 = 1 , matrix 1 = 1 and the identification decoder is in the mode "dual")

MUTE lll = 0   SCART output are muted.

MUTE lll = 1   SCART output ON; power ON

                   (will be overwritten by MUTE 1 = 0 equal to all audio outputs muted)

                   MUTE lll is "or" wired with MUTE I.

b) Volume of Left / Right Loudspeaker

	MSB	•	•	•	•	•	•	LSB
Maximum volume	X	X	1	1	1	1	1	1
Max −1	X	X	1	1	1	1	1	0
Max −15	X	X	1	1	0	0	0	0
Max −55	X	X	0	0	1	0	0	0
MUTE	X	X	0	0	0	1	1	1
MUTE	X	X	0	0	0	0	0	0
MUTE	X	X	0	0	0	X	X	X
Power ON	0	0	0	0	0	0	0	1

c) Volume of Headphones

	MSB	•	•	•	•	•	•	LSB
Maximum volume	T2	T1	T0	1	1	1	1	1
Max −1	T2	T1	T0	1	1	1	1	0
Max −15	T2	T1	T0	1	0	0	0	0
Max −31	T2	T1	T0	0	0	0	0	1
MUTE	T2	T1	T0	0	0	0	0	0
Power ON	0	0	0	0	0	0	0	1

T0, T2 are test bits; these must be set to 0 for normal operation

d) Crosstalk Compensation Matrix (sound 1)

	MSB	•	•	•	•	•	•	LSB
Max. amplification	0	0	0	1	1	1	1	1
Max −1	0	0	0	1	1	1	1	0
Gain 0 dB	0	0	0	1	0	0	0	0
Min. gain	0	0	0	0	0	0	0	1
Min. gain	0	0	0	0	0	0	0	X
Power ON	0	0	0	0	0	0	0	1

e) Treble/Bass

	MSB	•	•	•	•	•	•	LSB
Linear	1	0	0	0	1	0	0	0
Max. treble, lin. bass	1	1	0	0	1	0	0	0
Max. treble, lin. bass	1	1	X	X	1	0	0	0
Min. treble, lin. bass	0	1	0	0	1	0	0	0
Min. treble, lin. bass	0	0	X	X	1	0	0	0
Lin. treble, max. bass	1	0	0	0	1	1	0	1
Lin. treble, max. bass	1	0	0	0	1	1	X	1
Lin. treble, max. bass	1	0	0	0	1	1	1	X
Lin. treble, min. bass	1	0	0	0	0	1	0	0
Lin. treble, min. bass	1	0	0	0	0	0	X	X
Max. treble, max. bass	1	1	X	X	1	1	X	1
Min. treble, min. bass	0	0	X	X	0	0	X	X
Power ON	0	0	0	0	0	0	0	1
	MSB			LSB	MSB			LSB
	treble			treble	bass			bass

f) Switch Byte I

MSB	•	•	•	•	•	•	LSB
MUTE I	MUTE II	CH1/CH2LS	CH1/CH2KH	Mono	SCART	SCART-D	AM

MUTE I   = 0   All AF-outputs are muted (speakers, headphones, SCART); power ON

MUTE I   = 1   All AF-outputs ON

MUTE II   = 0   Loudspeaker outputs muted; power ON

MUTE II   = 1   Loudspeaker outputs ON

MUTE I and MUTE II are OR gated with respect to the loudspeaker outputs

MUTE I and MUTE III are OR gated with respect to the SCART output

MUTE I	MUTE II	MUTE III	Loudspeaker output	Headphone output	SCART output
0	0	0	muted	muted	muted
0	0	1	muted	muted	muted
0	1	0	muted	muted	muted
0	1	1	muted	muted	muted
1	0	0	muted	ON	muted
1	0	1	muted	ON	ON
1	1	0	ON	ON	muted
1	1	1	ON	ON	ON

Ch1/Ch2LS   =   0   Sound 1 on the loudspeaker outputs; power ON
Ch1/Ch2LS   =   1   Sound 2 on the loudspeaker outputs
Ch1/Ch2KH   =   0   Sound 1 on the headphone outputs; power ON
Ch1/Ch2KH   =   1   Sound 2 on the headphone outputs

Ch1/Ch2LS and Ch1/Ch2KH are only effective if the matrix is set to the position "dual sound".

Mono   =   0   identification signal decoder is set to the position mono and held; power ON
Mono   =   1   normal operation if ID-signal decoder
SCART   =   0   normal TV-operation; power ON
SCART   =   1   SCART playback; connection of SCART inputs - AF - outputs SCART = 1 has priority over AM = 1 (loudspeaker and head-phones)

SCART-D   =   0   SCART-playback stereo (mono); power ON
SCART-D   =   1   Enable for the Ch1/Ch2 switch during SCART playback. (only effective when SCART = 1)
AM   =   0   Normal operation (G-standard)
AM   =   1   AM AF-input is activated; power ON AM = 1 has priority over bypass = 1

Qu-H, Ch1/Ch2EN, Ch1/Ch2SC MUTE III see chapter Control Bytes a).

g) Switch Byte II

MSB	•	•	•	•	•	•	LSB
MPX0	MPX1	Quasi-st	BS	H-pulse	Matrix 0	Matrix 1	Bypass

MPX0	MPX1	MPX-period		recommended $C_{25,\,26}$	permissible crystal tolerance
0	0	2 s	power ON	1 µF	
0	1	4 s		2.2 µF	
1	0	8 s		4.7 µF	

special for crystal operation recommended adjustments:

0	0	2 s		470 nF	± 40 ppm
0	1	4 s		330 nF	± 70 ppm

MPX period = 2 s signifies: ID-signal decoder searches 1 second dual and 1 second stereo.
It is inprinciple permitted to make with given $C_{25,\,26}$ the MPX-period higher than indicated, but not lower.

Quasi stereo	=	0	Quasi stereo OFF; power ON
Quasi stereo	=	1	Quasi stereo ON
Bb	=	0	Stereo base width expansion OFF; power ON
Bb	=	1	Stereo base width expansion ON;

H-pulse	=	0	ID-signal decoder synchronization with f_H = 15.625 kHz; power ON
H-pulse	=	1	ID-synchronization with 4 x f_H (has to be set to 1 during operation with crystal or 4-MHz reference frequency)

Matrix 0	Matrix1	Matrix status	
0	0	mono	power ON
0	1	stereo	
1	0	dual	
1	1	automatic according to ID-signal decoder	

Bypass =	0	Normal operations (G-standard)
Bypass =	1	Matrix is bridge so that left/right signals can be fed; power ON (AM = 1 has priority over bypass = 1)

Priority List of Setting Bits

1. MUTE I

2. MUTE II (only with regard to the loudspeaker output)

3. SCART

4. AM

5. Bypass

6. Matrix 0, 1

h) Talk Mode

| MS	•	•	•	•	•	•	LSB
St	D	T3	T4	T5	CL	X	X
0	0	decoder detects mono					
1	0	decoder detects stereo					
0	1	decoder detects dual					
1	1	internally inhibited					
CL = 1		The signal path for the loudspeaker reached the clipping level (The bit CL is automatical reset)					

T3 - T5 are test bits

Pin Functions

| Pin No.	Function
1	AF-input mono, left, sound 1 (may be balanced)
2	Bias for AF-operating point
3	AF-input right, sound 2
4	54-kHz input
5	54-kHz filter
6	AF-input (L-standard)
7	AF-input SCART left (sound 1)
8	AF-input SCART right (sound 2)
9	AF-output SCART (mono, sound 1, left)
10	AF-output SCART (mono, sound 2, right)
11	Phase shifter quasi stereo
12	Phase shifter quasi stereo
13	Cut-off frequency bass (base width) left
14	Cut-off frequency bass (base width) right
15	AF-output, loudspeaker right
16	AF-output, loudspeaker left
17	Cut-off frequency treble left
18	Cut-off frequency treble right
19	AF-output, headphones right
20	AF-output, headphones left
21	+ V_S (supply voltage)
22	I^{2}C Bus SCL
23	I^{2}C Bus SDA
24	Input H-pulse (4 x H-pulse), crystal oscillator
25	Filter ID-signal decoder
26	Filter ID-signal decoder
27	PLL-filter ID-signal decoder
28	Ground
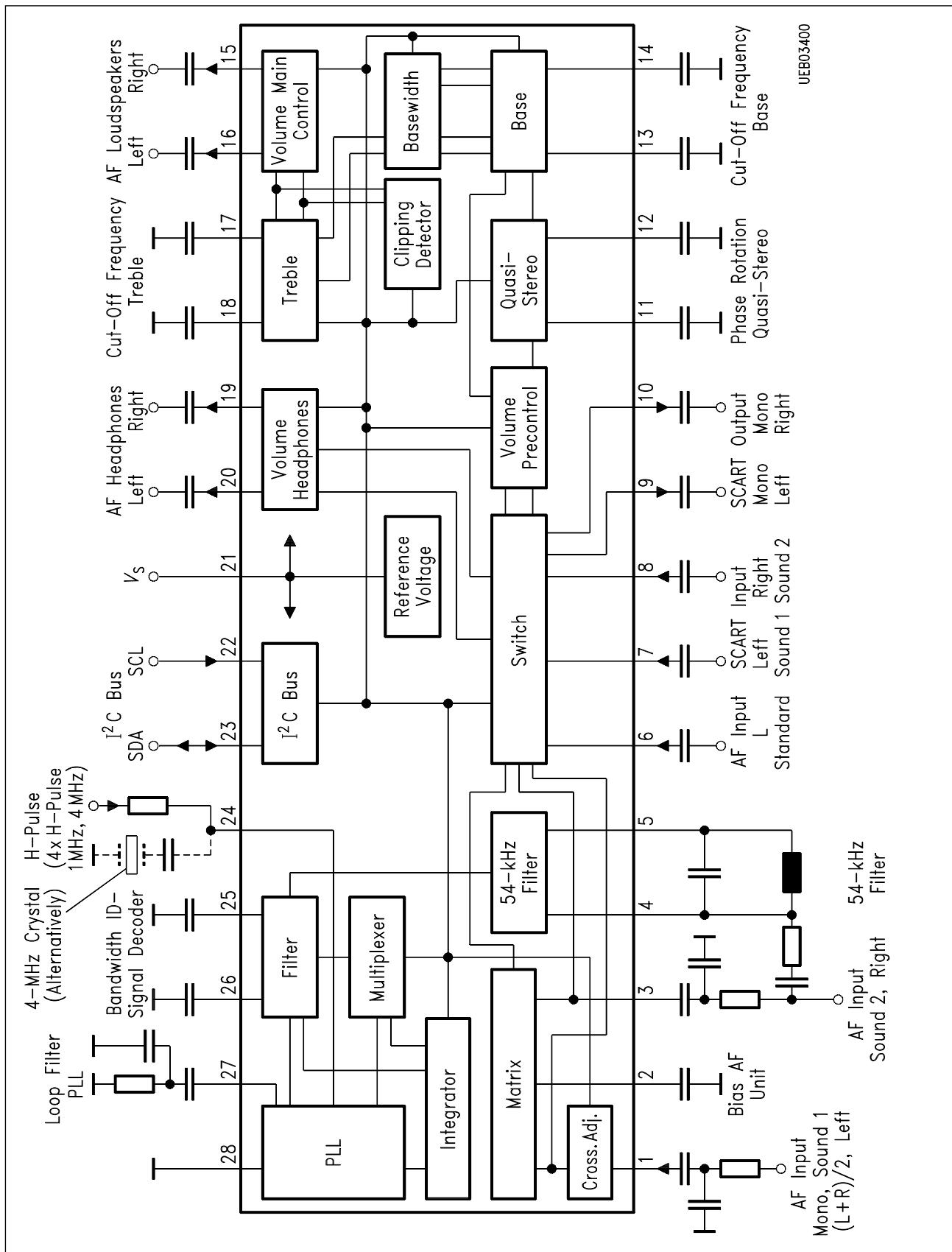
Block Diagram
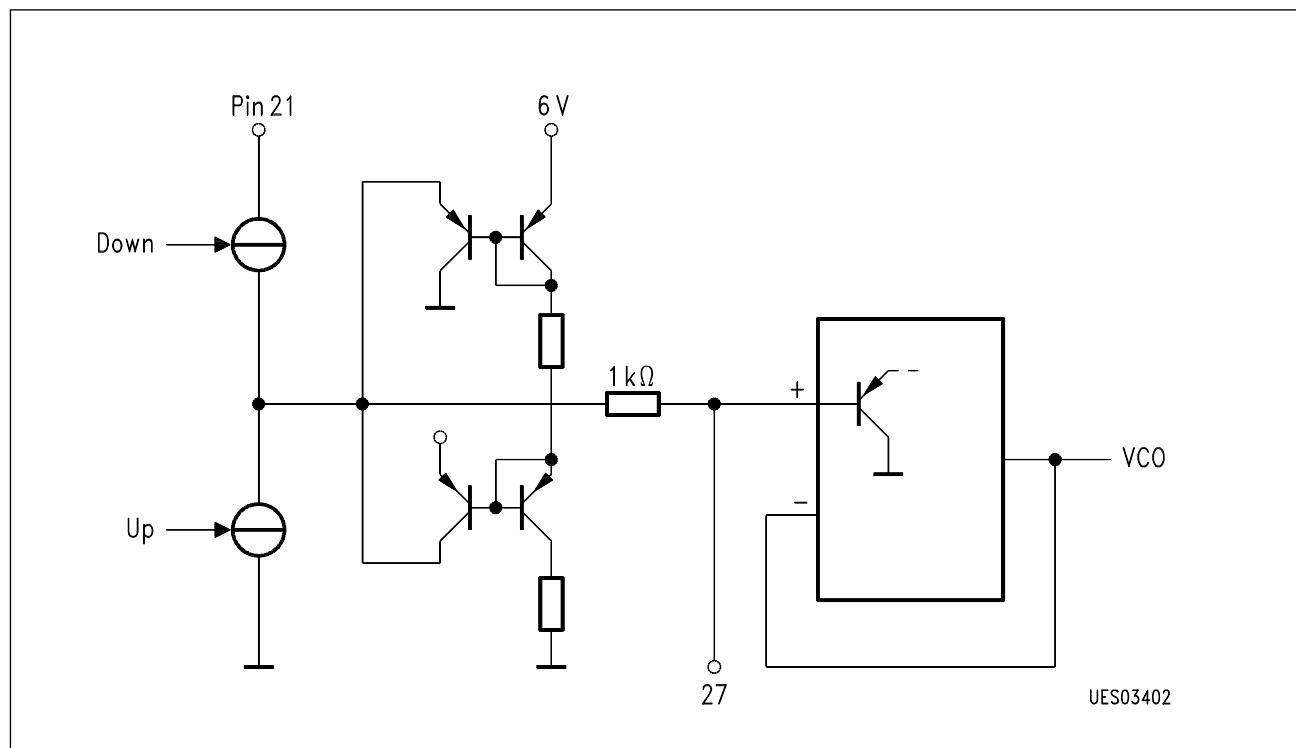
**PLL Filter ID-Signal Decoder (Pin 27)**
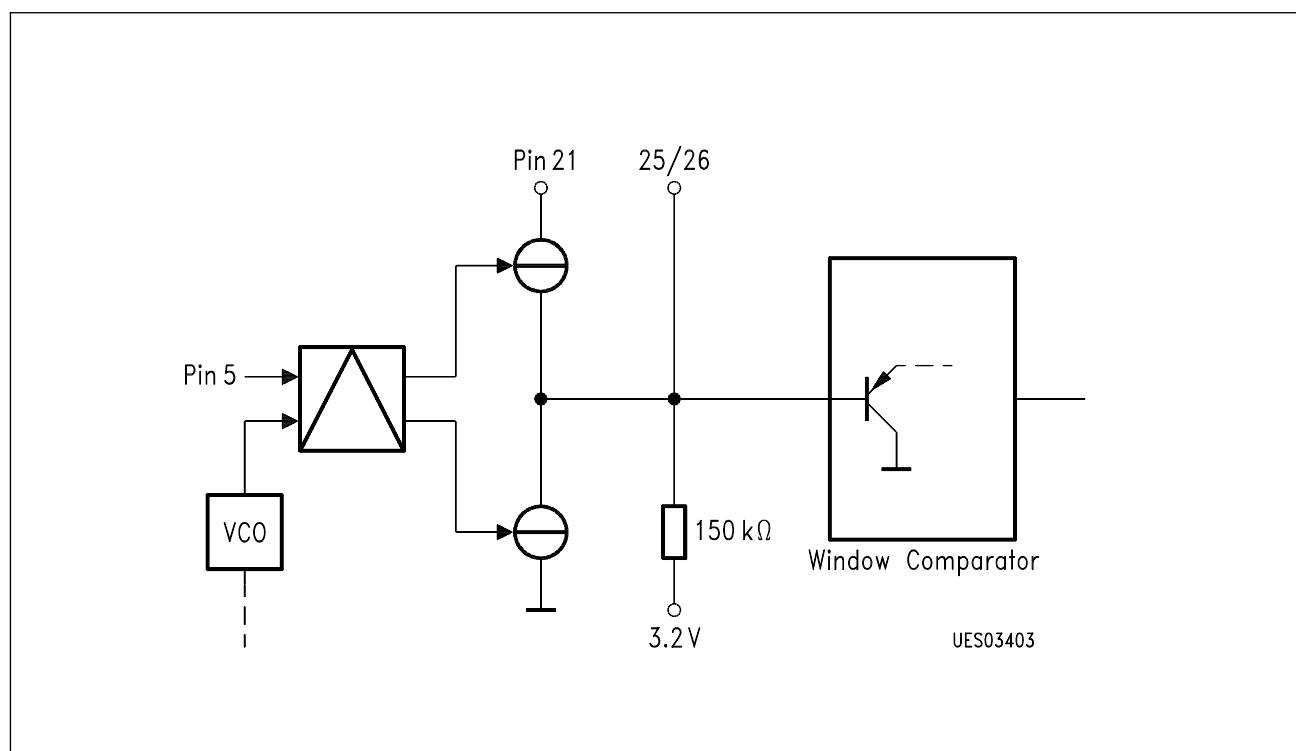
Filter ID-Signal Decoder (Pin 25/26)
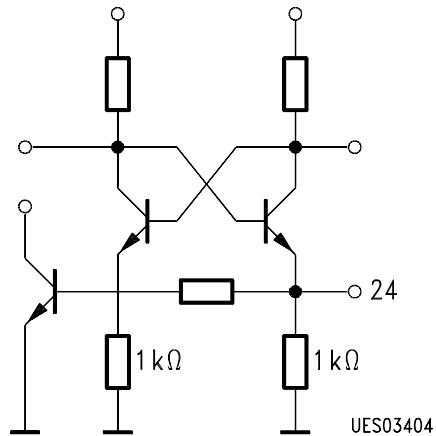
H-Pulse/Crystal Oscillator (Pin 24)

I²C Bus SDA (Pin 23)

UES05877

I²C Bus SCL (Pin 22)

50 Ω

19/20
15/16
9/10

UES05878
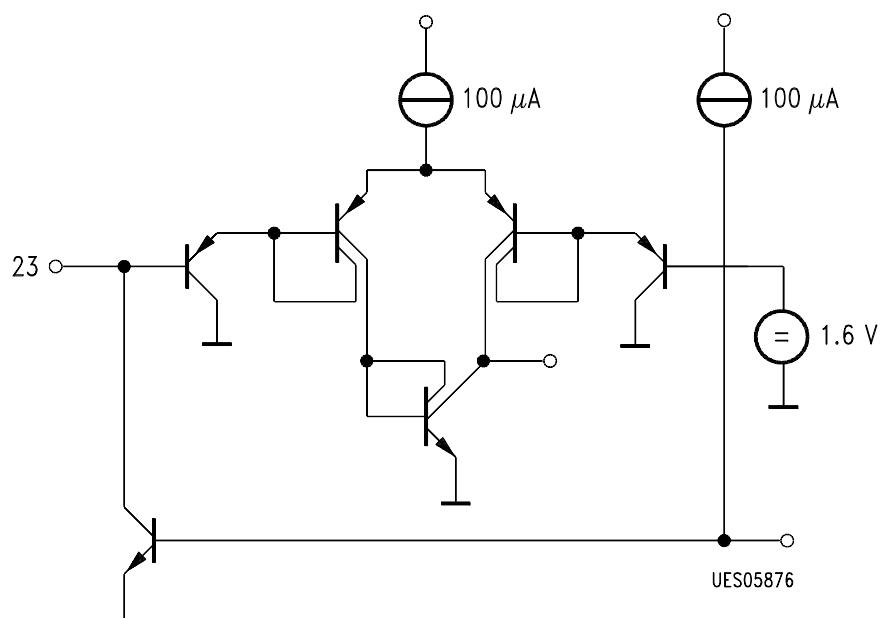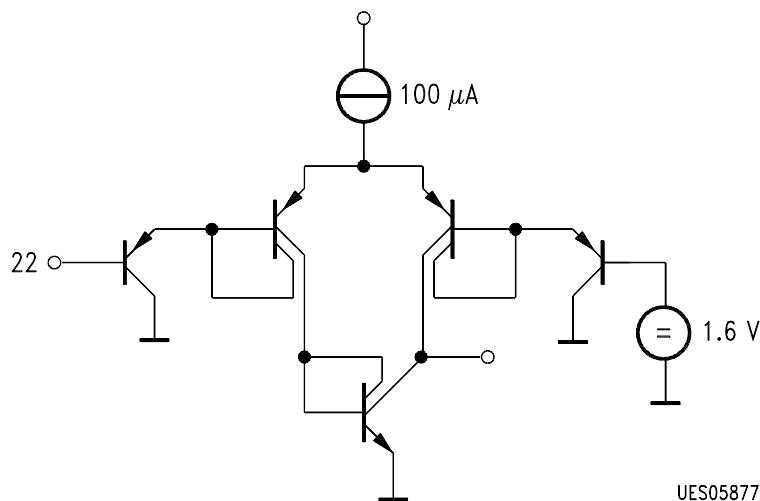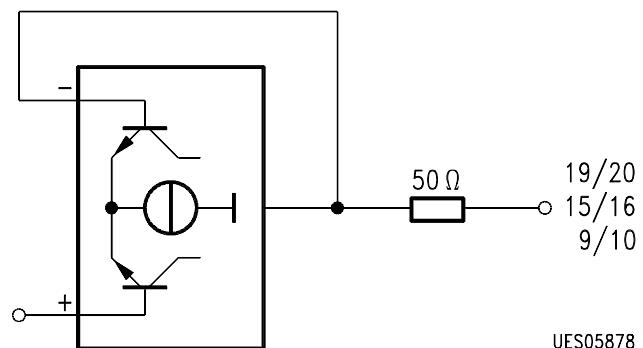
AF-Outputs Headphones (Pin 19/20)
Loudspeaker (Pin 15/16)
SCART (Pin 9/10)

21.2 kΩ　16 kΩ　11.2 kΩ　8.1 kΩ　19.3 kΩ

20 μA

17/18

UES03408
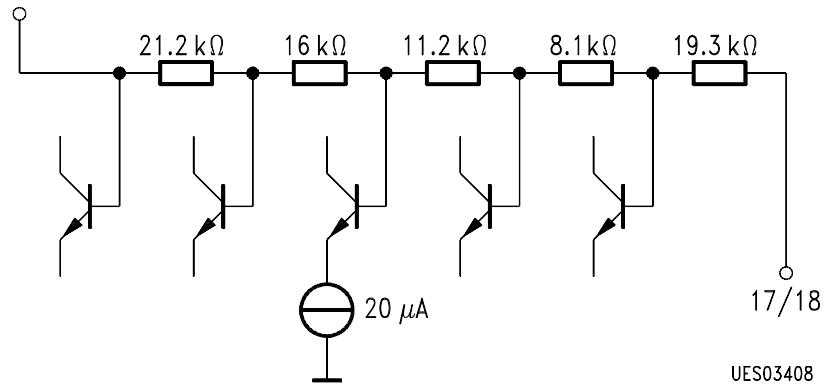
Cut-Off Frequency Treble (Pin 17/18)

33 kΩ　　33 kΩ

13/14

33 kΩ

200 μA

UES03409
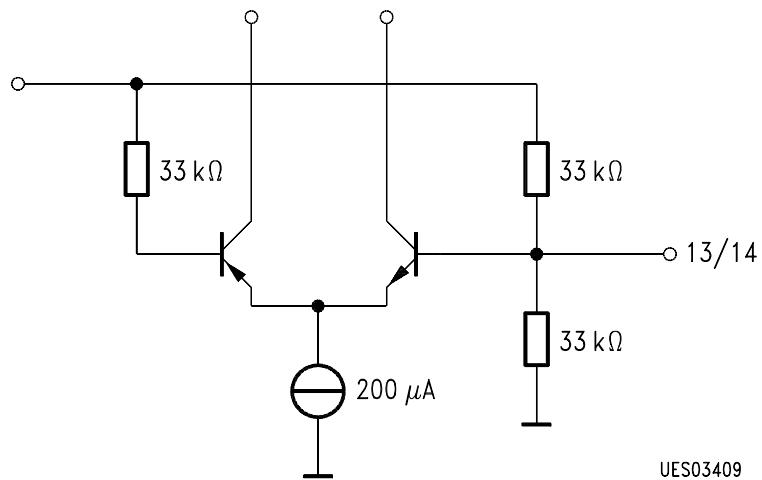
Cut-Off Frequency Bass (Pin 13/14)
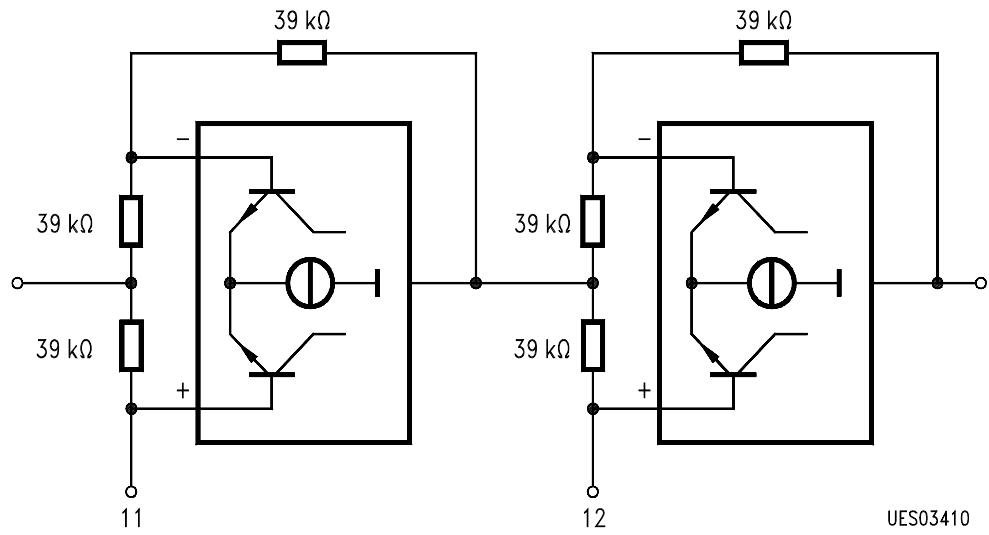
Phase Advancer Quasi Stereo (Pin 11/12)
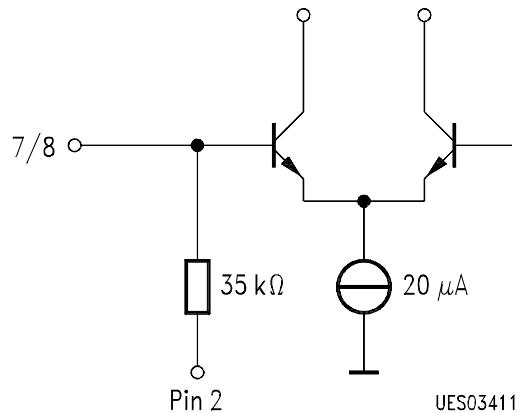
AF-Inputs SCART (Pin 7/8)

AF-Input AM (Pin 6)

UES05879

54-kHz Filter (Pin 4/5)

UES03414

AF-Input (Pin 3)

Pin 21

10 kΩ

2

10 kΩ

UES03415
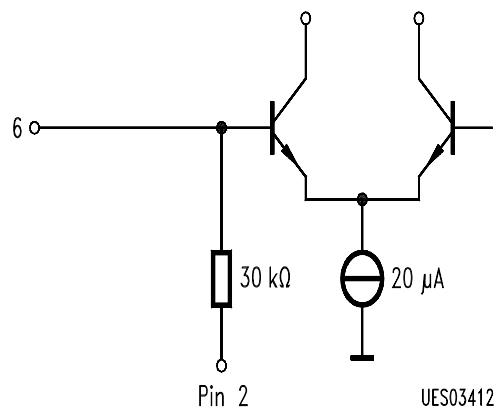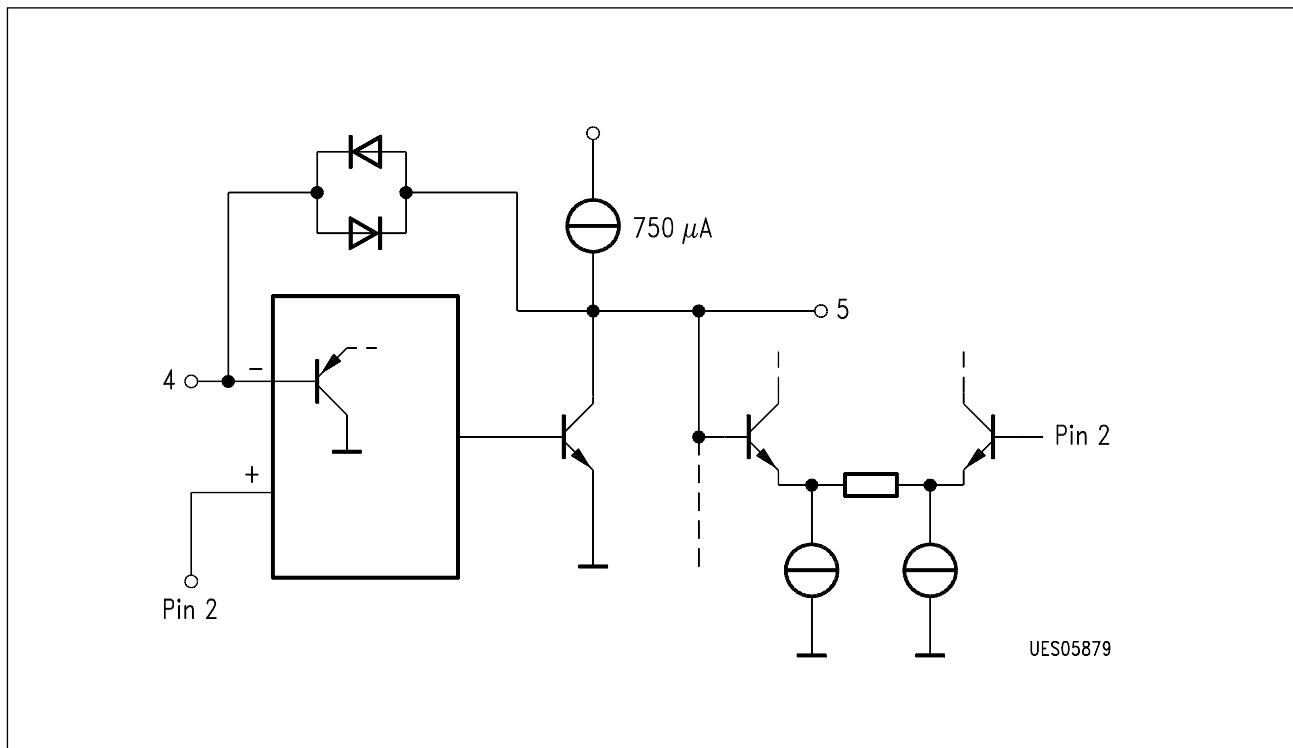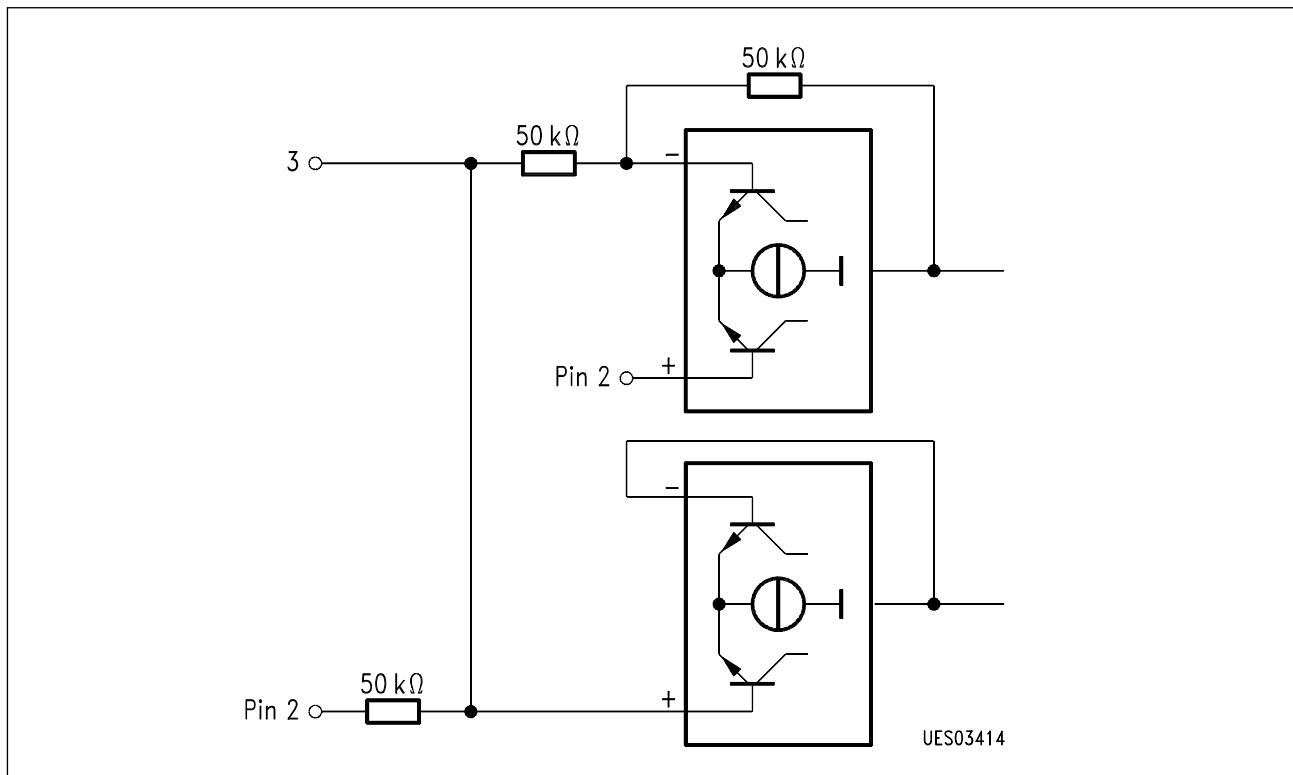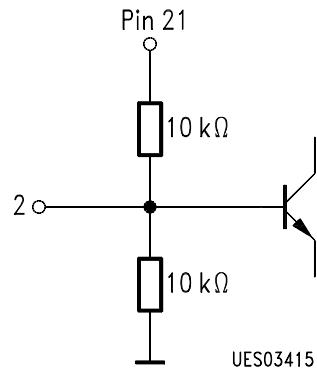
Input for AF-Unit Bias Blocking Capacitor (Pin 2)

1

50 kΩ

20 μA

Pin 2

UES03416
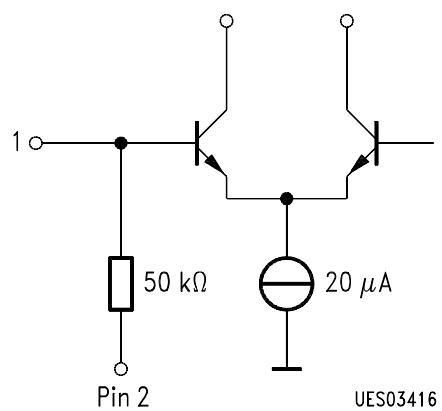
AF-Input (Pin 1)

Absolute Maximum Ratings

T_A = 0 to 70 ^{o}C; all voltages relatives to V_{ss}

| Parameter	Symbol	Limit Values		Unit	Remarks
		min.	max.		
Supply voltage	V_{21}	0	14	V	
Max. DC-voltage	V_1	0	V_{21}	V	
Max. DC-voltage	V_2	0	V_{21}	V	
Max. DC-voltage	V_3	0	V_{21}	V	
Max. DC-voltage	V_4	0	V_{21}	V	
Max. DC-voltage	V_6	0	V_{21}	V	
Max. DC-voltage	V_7	0	V_{21}	V	
Max. DC-voltage	V_8	0	V_{21}	V	
Max. DC-voltage	V_{11}	0	V_{21}	V	
Max. DC-voltage	V_{12}	0	V_{21}	V	
Max. DC-voltage	V_{13}	0	V_{21}	V	
Max. DC-voltage	V_{14}	0	V_{21}	V	
Max. DC-voltage	V_{17}	0	V_{21}	V	
Max. DC-voltage	V_{18}	0	V_{21}	V	
Max. DC-voltage	V_{22}	0	V_{21}	V	
Max. DC-voltage	V_{23}	0	V_{21}	V	
Max. DC-voltage	V_{24}	0	V_{21}	V	
Max. DC-voltage	V_{25}	0	V_{21}	V	
Max. DC-voltage	V_{26}	0	V_{21}	V	
Max. DC-current	I_5	0	2	mA	
Max. DC-current	I_9	0	2	mA	
Max. DC-current	I_{10}	0	2	mA	
Max. DC-current	I_{15}	0	2	mA	
Max. DC-current	I_{16}	0	2	mA	
Max. DC-current	I_{19}	0	2	mA	
Max. DC-current	I_{20}	0	2	mA	
Max. DC-current	I_{27}	0	1	mA	

Absolute Maximum Ratings (cont'd)

Parameter	Symbol	Limit Values		Unit	Remarks
		min.	max.		
ESD-voltage	V_{ESD}	-2	2	kV	HBM (R = 1.5 kΩ, C = 100 pF)
ESD-voltage	$V_{ESD7,8,9,10}$	-6	6	kV	HBM (R = 1.5 kΩ, C = 100 pF)
Junction temperature	T_j		150	^oC	
Storage temperature	T_{stg}	-40	125	^oC	
Thermal resistance system ambient	$R_{th\,SA}$		53	K/W	

Operating Range

Parameter	Symbol	min.	max.	Unit	Remarks
Supply voltage	V_6	10	13.2	V	
Ambiente temperature	T_A	0	70	^oC	
Input frequency range	f_I	0.01	20	kHz	

Characteristics

V_S = 12 V; T_A = 25 $^{\circ}$C, audio reference level 0 dB–250 mVrms, if not differently defined.

I^{2}C Bus preset: start - 84 - 01,3F - 0 2,3F - 04,00 - 0 3,1F - 0 5,88 - 0 6,10 - 07,C8 - 00,01 - stop

Chip address - *Vol $_{LSl}$ 63 - Vol $_{LSr}$ 63 - Vol $_{VLs}$ - Vol $_{HP}$ 31 - Sound lin Adjust 0dB - MUTE I, MUTE II, Mono - Bypass*

The basic setting for each point in the specification is always preset; only settings which deviate from this are given in the test conditions. Details in *italics* only provide explanation of the hexadecimal codes. If switch byte are mentioned only the bit status and activated features are indicated.

Parameter	Symbol	Limit Values			Unit	Test Condition
		min.	typ.	max.		(in accordance with test circuit 1)
Current consumption	I_{21}		58.	80	mA	
Signal Section						
Max. gain	$V_{16\text{-}1}$	-2	0	2	dB	
Max. gain	$V_{15\text{-}3}$	-2	0	2	dB	
Max. gain	$V_{20\text{-}1}$	-2	0	2	dB	
Max. gain	$V_{19\text{-}3}$	-2	0	2	dB	
Max. gain	$V_{16\text{-}3}$	-2	0	2	dB	00,02; V_1 = 01 *Matrix: Stereo*
Max. gain	$V_{15\text{-}3}$	-2	0	2	dB	00,02; V_1 = 01 *Matrix: Stereo*
Max. gain	$V_{20\text{-}3}$	-2	0	2	dB	00,02; V_1 = 0 *Matrix: Stereo*
Max. gain	$V_{19\text{-}3}$	-2	0	2	dB	00,02; V_1 = 0 *Matrix: Stereo*
Max. gain	$V_{16\text{-}1}$	4	6	8	dB	00,02; V_3 = 0 *Matrix: Stereo*
Max. gain	$V_{20\text{-}1}$	4	6	8	dB	00,02; V_3 = 0 *Matrix: Stereo*
Max. gain	$V_{16\text{-}7}$	-2	0	2	dB	07,CC, *SCART*
Max. gain	$V_{15\text{-}8}$	-2	0	2	dB	07,CC, *SCART*
Max. gain	$V_{20\text{-}7}$	-2	0	2	dB	07,CC, *SCART*
Max. gain	$V_{19\text{-}8}$	-2	0	2	dB	07,CC, *SCART*
Max. gain	$V_{16\text{-}6}$	-2	0	2	dB	07,C9, *AM*
Max. gain	$V_{15\text{-}6}$	-2	0	2	dB	07,C9, *AM*
Max. gain	$V_{20\text{-}6}$	-2	0	2	dB	07,C9, *AM*
Max. gain	$V_{19\text{-}6}$	-2	0	2	dB	07,C9, *AM*

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TDA 6612-2

Characteristics (cont'd)

Parameter	Symbol	Limit Values			Unit	Test Condition
		min.	typ.	max.		
Gain	$V_{9\text{-}1}$	-2	0	2	dB	
Gain	$V_{10\text{-}3}$	-2	0	2	dB	
Gain	$V_{9\text{-}3}$	-2	0	2	dB	
Gain	$V_{10\text{-}3}$	-2	0	2	dB	00,02; $V_1 = 0$ _Matrix: Stereo_
Gain	$V_{9\text{-}1}$	4	6	8	dB	00,02; $V_1 = 0$ _Matrix: Stereo_
Gain	$V_{10\text{-}6}$	-2	0	2	dB	00,02; $V_1 = 0$ _Matrix: Stereo_
Gain	$V_{9\text{-}6}$	-2	0	2	dB	07,C9, _AM_
Min. gain Main control	$V_{16\text{-}1}$		-70	-65	dB	01,08-02,08 _Vol_ $_{LSi}$ 8 $-$ _Vol_ $_{LSr}$ 8
Min. gain Main control	$V_{15\text{-}3}$		-70	-65	dB	01,08-02,08 _Vol_ $_{LSi}$ 8 $-$ _Vol_ $_{LSr}$ 8
Min. gain 1st. control	$V_{16\text{-}1}$	-17	-15	-13	dB	04,18 _Vol_ $_{VLS}$ 24
Min. gain 1st. control	$V_{15\text{-}3}$	-17	-15	-13	dB	04,18 _Vol_ $_{VLS}$ 24
Min. gain	$V_{20\text{-}1}$		-62	-57	dB	03,01, _Vol_ $_{HP}$ 1
Min. gain	$V_{19\text{-}3}$		-62	-57	dB	03,01, _Vol_ $_{HP}$ 1

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Characteristics (cont'd)

Parameter	Symbol	Limit Values			Unit	Test Condition
		min.	typ.	max.		
Analogous values are valid for feed in at the pins 6, 7 and 8						
Channel tracking error	$\Delta V_{15\text{-}16}$			± 2	dB	01,3F to 01,24 02,3F to 02,24 *Vol $_{LSl}$ 63-36 – Vol $_{LSr}$ 63-36*
Channel tracking error	$\Delta V_{19\text{-}26}$			± 2	dB	03,1F to 03,13 *Vol $_{HP}$ 31-19*
Step width Vol $_{15}$	ΔV_{15}	0	1.25	2.5	dB	01,X-01,(X $\pm$ 1) *Vol $_{LSl}$ X – Vol $_{LSl}$ (X $\pm$ 1)*
Step width Vol $_{16}$	ΔV_{16}	0	1.25	2.5	dB	02,X-02,(X $\pm$ 1) *Vol $_{LSr}$ X – Vol $_{LSr}$ (X $\pm$ 1)*
Step width Vol $_{15}$	ΔV_{15}	0	1.25	2.5	dB	04,X-04,(X $\pm$ 1) *Vol $_{VLS}$ X – Vol $_{VLS}$ (X $\pm$ 1)*
Step width Vol $_{16}$	ΔV_{16}	0	1.25	2.5	dB	04,X-04,(X $\pm$ 1) *Vol $_{VLS}$ X – Vol $_{VLS}$ (X $\pm$ 1)*
Step width Vol $_{19}$	ΔV_{19}	0	2	4	dB	03,X-03,(X $\pm$ 1) *Vol $_{HP}$ X – Vol $_{HP}$ (X $\pm$ 1)*
Step width Vol $_{20}$	ΔV_{20}	0	2	4	dB	03,X-03,(X $\pm$ 1) *Vol $_{HP}$ X – Vol $_{HP}$ (X $\pm$ 1)*
Matrix adjustment	$V_{16\text{-}1}$	2.5	3	3.5	dB	06,1F, *Adjust. max*
Matrix adjustment	$V_{20\text{-}1}$	2.5	3	3.5	dB	06,1F, *Adjust. max*
Matrix adjustment	$V_{9\text{-}1}$	2.5	3	3.5	dB	06,1F, *Adjust. max*
Matrix adjustment	$V_{16\text{-}1}$	-3.5	-3	-2.5	dB	06,01, *Adjust. min*
Matrix adjustment	$V_{20\text{-}1}$	-3.5	-3	-2.5	dB	06,01, *Adjust. min*
Matrix adjustment	$V_{9\text{-}1}$	-3.5	-3	-2.5	dB	06,1F, *Adjust. max*
Adjust. step width	ΔV_{16}	0.1	0.2	0.3	dB	06,X-06,(X $\pm$ 1) *Adjust. X – adjust. (X $\pm$ 1)*

Characteristics (cont'd)

Parameter	Symbol	Limit Values			Unit	Test Condition
		min.	typ.	max.		
Adjust. step width	ΔV_{20}	0.1	0.2	0.3	dB	06,X-06,(X ± 1) *Adjust. X – adjust. (X ± 1)*
Adjust. step width	ΔV_9	0.1	0.2	0.3	dB	06,X-06,(X ± 1) *Adjust. X – adjust. (X ± 1)*
Bass boost	$V_{16\text{-}1}$	13	15		dB	05,8 F; f_l = 40 Hz *Bass max, treble lin.*
Bass boost	$V_{15\text{-}3}$	13	15		dB	05,8 F; f_l = 40 Hz *Bass max, treble lin.*
Bass cut	$V_{16\text{-}1}$		– 12		dB	05,8 F; f_l = 40 Hz *Bass max, treble lin.*
Bass cut	$V_{15\text{-}3}$		– 12		dB	05,8 F; f_l = 40 Hz *Bass max, treble lin.*
Step width bass	ΔV_{15}	1	3	5	dB	05,8X-05,8 (X ± 1) *Bass X – bass (X ± 1)*
Step width bass	ΔV_{16}	1	3	5	dB	05,8X-05,8 (X ± 1) *Bass X – bass (X ± 1)*

Characteristics (cont'd)

Parameter	Symbol	Limit Values			Unit	Test Condition
		min.	typ.	max.		
Treble boost	$V_{16\text{-}1}$	10	12		dB	05,8 F; f_l = 15 Hz *Treble max, bass lin.*
Treble boost	$V_{15\text{-}3}$	10	12		dB	05,8 F; f_l = 15 Hz *Treble max, bass lin.*
Treble cut	$V_{16\text{-}1}$		– 12		dB	05,8 F; f_l = 15 Hz *Treble max, bass lin.*
Treble cut	$V_{15\text{-}3}$		– 12		dB	05,8 F; f_l = 15 Hz *Treble max, bass lin.*
Step width bass	ΔV_{15}	1	3	5	dB	05,X8-05 (X ± 1)8 *Treble X – treble (X ± 1)*
Step width bass	ΔV_{16}	1	3	5	dB	05,X8-05 (X ± 1)8 *Treble X – treble (X ± 1)*
Linearity sound	ΔV_{15}			± 2	dB	05,88; f_l = 40 Hz – 15 kHz *Treble, bass lin.*
Linearity sound	ΔV_{16}			± 2	dB	05,88; f_l = 40 Hz – 15 kHz *Treble, bass lin.*
Detection level of the clipping detector	V_1		580		mVrms	05,8 F; f_l = 40 Hz *Treble lin, bass* max. 01,2F - 02,2F *Vol $_{LSl}$ 47 – Vol $_{LSr}$ 47*

The same values are valid if the test signals are applied at pin 3, 6, 7 or 8

Parameter	Symbol	Limit Values			Unit	Test Condition
Channel separation	$\Delta V_{15\text{-}16}$	50			dB	V_3 or V_8 = 600 mVrms
Channel separation of the clipping	$\Delta V_{19\text{-}20}$	50			dB	V_3 or V_8 = 600 mVrms
Channel separation	$\Delta V_{9\text{-}10}$	50			dB	V_3 or V_8 = 600 mVrms
Cross talk attenuation switch	$\alpha_{\text{I interf / Q rms}}$					$V_{\text{I rms}}$ = 0 $V_{\text{I Interf, 3,6}}$ = 600 mVrms
		60			dB	$V_{\text{I Interf, 7,8}}$ = 2 Vrms

Characteristics (cont'd)

Parameter	Symbol	Limit Values			Unit	Test Condition
		min.	typ.	max.		
Attenuation MUTE	$\alpha_{1\text{-}16}$	80			dB	01,00 - 02,00 $Vol_{LSl}\ 0 - Vol_{LSr}\ 0$ $V_1 = 600$ mVrms
Attenuation MUTE	$\alpha_{1\text{-}16}$	80			dB	07,48; $V_1 = 600$ mVrms *MUTE I: 0*
Attenuation MUTE	$\alpha_{1\text{-}16}$	80			dB	07,88; $V_1 = 600$ mVrms *MUTE II: 0*
Attenuation MUTE	$\alpha_{3\text{-}15}$	80			dB	01,00 - 02,00 $Vol_{LSl}\ 0 - Vol_{LSr}\ 0$ $V_3 = 600$ mVrms
Attenuation MUTE	$\alpha_{3\text{-}15}$	80			dB	07,48; $V_3 = 600$ mVrms *MUTE I: 0*
Attenuation MUTE	$\alpha_{3\text{-}15}$	80			dB	07,88; $V_3 = 600$ mVrms *MUTE II: 0*
Attenuation MUTE	$\alpha_{1\text{-}20}$	80			dB	03,00; $V_1 = 600$ mVrms $Vol_{HP}\ 0$
Attenuation MUTE	$\alpha_{1\text{-}20}$	80			dB	07,48; $V_1 = 600$ mVrms *MUTE I: 0*

Characteristics (cont'd)

Parameter	Symbol	Limit Values			Unit	Test Condition
		min.	typ.	max.		
Attenuation MUTE	$\alpha_{3\text{-}19}$	80			dB	03,00; $V_3 = 600$ mVrms *MUTE I: 0*
Attenuation MUTE	$\alpha_{3\text{-}19}$	80			dB	07,48; $V_1 = 600$ mVrms *MUTE I: 0*
Analogous values are valid for feed in at pins 6, 7, 8; $V_{7,8} = 2$ Vrms; $V_6 = 600$ mVrms						
Attenuation MUTE	$\alpha_{3\text{-}10}$	80			dB	07,48; $V_3 = 600$ mVrms *MUTE I: 0*
Attenuation MUTE	$\alpha_{1\text{-}9}$	80			dB	07,48; $V_1 = 600$ mVrms *MUTE I: 0*
Attenuation MUTE	$\alpha_{6\text{-}10}$	80			dB	07,49; $V_6 = 600$ mVrms *MUTE I: 0, AM*
Attenuation MUTE	$\alpha_{6\text{-}9}$	80			dB	07,49; $V_6 = 600$ mVrms *MUTE I: 0, AM*
Max. input voltage	V_6	600			mVrms	$THD_{15,\,16} = 1\%$
Max. input voltage	V_3	600			mVrms	$THD_{15} = 1\%$
Max. input voltage	V_3	600			mVrms	$THD_{16} = 1\%$
Max. input voltage	V_1	300			mVrms	$THD_{16} = 1\%$; 00,02 *Matrix; Stereo*
Max. input voltage*)	V_7	2			Vrms	$THD_{16} = 3\%$; 07, *CC, Scart*
Max. input voltage*)	V_8	2			Vrms	$THD_{15} = 1\%$; 07, *CC, Scart*

*) The tone control is possible over the full functional range if 04, 18, *Vol $_{VLS}$ 24*

Characteristics (cont'd)

Parameter	Symbol	Limit Values			Unit	Test Condition
		min.	typ.	max.		
Distortion	THD_{19}		0.01	0.1	%	V_3 = 250 mVrms
Distortion	THD_{20}		0.01	0.1	%	V_1 = 250 mVrms
Distortion	THD_{19}		0.01	0.1	%	V_3 = 250 mVrms; 03,15 *Vol $_{HP}$ 21*
Distortion	THD_{20}		0.01	0.1	%	V_3 = 250 mVrms; 03,15 *Vol $_{HP}$ 21*
Analogous values are valid for feed in at pins 6, 7, 8; $V_{7,8}$ = 600 Vrms; V_6 = 250 mVrms						
Distortion	THD_{16}		0.01	0.1	%	V_1 = 250 mVrms;
Distortion	THD_{15}		0.01	0.1	%	V_3 = 250 mVrms
Distortion	THD_{15}		0.01	0.2	%	V_1 = 250 mVrms; 01,2F-02,2F *Vol $_{LSl}$ 47 Vol $_{LSr}$ 47*
Distortion	THD_{15}		0.01	0.2	%	V_3 = 250 mVrms; 01,2F-02,2F *Vol $_{LSl}$ 47 Vol $_{LSr}$ 47*
Distortion	THD_{16}		0.1	0.4	%	V_1 = 250 mVrms; 05,XX any sound
Distortion	THD_{15}		0.1	0.4	%	V_3 = 250 mVrms; 05,XX any sound
Analogous values are valid for feed in at pins 6, 7, 8; $V_{7,8}$ = 600 mVrms; V_6 = 250 mVrms						
Distortion	THD_{10}		0.01	0.1	%	V_3 = 250 mVrms
Distortion	THD_9		0.01	0.1	%	V_1 = 250 mVrms
Distortion	THD_{10}		0.01	0.1	%	V_6 = 250 mVrms; 07,C9,*AM*
Distortion	THD_9		0.01	0.1	%	V_6 = 250 mVrms; 07,C9,*AM*

Characteristics (cont'd)

Parameter	Symbol	Limit Values			Unit	Test Condition
		min.	typ.	max.		
Anti-phase cross talk Base width	$\Delta V_{16\text{-}15}$	0.5	0.55			V_3 = 600 mVrms f_I = 2 kHz; 00, 11 *Base width*
Anti-phase cross talk Base width	$\Delta V_{15\text{-}16}$	0.5	0.55			V_1 = 600 mVrms f_I = 2 kHz; 00, 11 *Base width*
Base width phase	$\Phi_{16\text{-}15}$	150	180	210	deg	V_1 = 600 mVrms f = 2 kHz; 00, 11 *Base width*
Base width phase	$\Phi_{15\text{-}16}$	150	180	210	deg	V_3 = 600 mVrms f = 2 kHz; 00, 11 *Base width*
Phase rotation quasi stereo	$\Phi_{16\text{-}15}$	0	10	40	deg	$V_{3,1}$ = 600 mVrms f = 40 kHz; 00, 21 *Quasi stereo*
Phase rotation quasi stereo	$\Phi_{16\text{-}15}$	130	180	230	deg	$V_{3,1}$ = 600 mVrms f = 700 kHz; 00, 21 *Quasi stereo*
Phase rotation quasi stereo	$\Phi_{16\text{-}15}$	– 30	10	0	deg	$V_{3,1}$ = 600 mVrms f = 15 kHz; 00, 21 *Quasi stereo*
Signal-to-noise ratio	$\alpha_{S/N16}$	85	94		dB	$V_{\text{N rms 20 Hz-20 kHz}}$; V_1 = 0.6 Vrms
Signal-to-noise ratio	$\alpha_{S/N15}$	85	94		dB	$V_{\text{N rms 20 Hz-20 kHz}}$; V_3 = 0.6 Vrms
Signal-to-noise ratio	$\alpha_{S/N16}$	60	70		dB	$V_{\text{N rms 20 Hz-20 kHz}}$; V_1 = 0.6 Vrms 01,27-02,27 *Vol$_{LSl}$ 39-Vol$_{LSr}$ 39*
Signal-to-noise ratio	$\alpha_{S/N15}$	60	70		dB	$V_{\text{N rms 20 Hz-20 kHz}}$; V_3 = 0.6 Vrms 01,27-02,27 *Vol$_{LSl}$ 39 – Vol$_{LSr}$ 39*

Characteristics (cont'd)

Parameter	Symbol	Limit Values			Unit	Test Condition
		min.	typ.	max.		
Output noise voltage	V_{N16}		12	33	μVrms	$V_{N rms}$ 20 Hz-20 kHz; 01,00-02,00 Vol_{LSl} 0-Vol_{LSr} 0
Output noise voltage	V_{N15}		12	33	μVrms	$V_{N rms}$ 20 Hz-20 kHz; 01,00-02,00 Vol_{LSl} 0-Vol_{LSr} 0
Signal-to-noise ratio	$\alpha_{S/N20}$	85	94		dB	$V_{N rms}$ 20 Hz-20 kHz; V_1 = 0.6 Vrms
Signal-to-noise ratio	$\alpha_{S/N19}$	85	94		dB	$V_{N rms}$ 20 Hz-20 kHz; V_3 = 0.6 Vrms
Signal-to-noise ratio	$\alpha_{S/N20}$	65	70		dB	$V_{N rms}$ 20 Hz-20 kHz; V_1 = 0.6 Vrms 03, 10, Vol_{HP} 16
Signal-to-noise ratio	$\alpha_{S/N19}$	65	70		dB	$V_{N rms}$ 20 Hz-20 kHz; V_3 = 0.6 Vrms 03, 10, Vol_{HP} 16
Output noise voltage	V_{N20}		12	33	μVrms	$V_{N rms}$ 20 Hz-20 kHz; 03, 00, Vol_{HP} 0
Output noise voltage	V_{N19}		12	33	μVrms	$V_{N rms}$ 20 Hz-20 kHz; 03, 00, Vol_{HP} 0
Signal-to-noise ratio	$\alpha_{S/N9}$	90	97		dB	$V_{N rms}$ 20 Hz-20 kHz; V_1 = 0.6 Vrms
Signal-to-noise ratio	$\alpha_{S/N10}$	90	97		dB	$V_{N rms}$ 20 Hz-20 kHz; V_1 = 0.6 Vrms

Characteristics (cont'd)

Parameter	Symbol	Limit Values			Unit	Test Condition
		min.	typ.	max.		
DC/pop $\Delta 1$ Bit	ΔV_{16}			± 4	mV	01, X-01, X $\pm$ 1 *Vol $_{LSl}$ X – Vol $_{LSl}$ (X $\pm$ 1)*
DC/pop $\Delta 1$ Bit	ΔV_{15}			± 4	mV	02, X-02, X $\pm$ 1 *Vol $_{LSr}$ X – Vol $_{LSr}$ (X $\pm$ 1)*
DC/pop $\Delta 1$ Bit	ΔV_{16}			± 4	mV	04, X-04, X $\pm$ 1 *Vol $_{VLS}$ X – Vol $_{VLS}$ (X $\pm$ 1)*
DC/pop $\Delta 1$ Bit	ΔV_{15}			± 4	mV	04, X-04, X $\pm$ 1 *Vol $_{VLS}$ X – Vol $_{VLS}$ (X $\pm$ 1)*
DC/pop $\Delta 1$ Bit	ΔV_{16}			± 2	mV	05, X-05, X $\pm$ 1 *ToneX – Tone (X $\pm$ 1)*
DC/pop $\Delta 1$ Bit	ΔV_{15}			± 2	mV	05, X-05, X $\pm$ 1 *ToneX – Tone (X $\pm$ 1)*
DC/pop $\Delta 1$ Bit	ΔV_{19}			± 4	mV	03, X-03, X $\pm$ 1 *Vol $_{HP}$ X – Vol $_{HP}$ (X $\pm$ 1)*
DC/pop $\Delta 1$ Bit	ΔV_{20}			± 4	mV	03, X-03, X $\pm$ 1 *Vol $_{HP}$ X – Vol $_{HP}$ (X $\pm$ 1)*
Design-Related Data						
Input resistance	R_7	35			kΩ	
Input resistance	R_8	35			kΩ	
Input resistance	R_6	20			kΩ	
Input resistance	R_3	22			kΩ	
Input resistance	R_1	22			kΩ	
Output resistance	R_{19}			70	Ω	
Output resistance	R_{20}			70	Ω	
Output resistance	R_{15}			70	Ω	
Output resistance	R_{16}			70	Ω	
Output resistance	R_9			70	Ω	
Output resistance	R_{10}			70	Ω	

Characteristics (cont'd)

Parameter	Symbol	Limit Values			Unit	Test Condition	Test Circuit
		min.	typ.	max.			
ID-Signal Decoder							
Gain filter OP-amplif.	V_5	13	14	15	dB	$V_{IF} = 80$ mVpp	1
Max. input voltage	V_5	600			mVpp	Function	2
VCO-voltage PLL	V_{27}	1.3			V	$f_{24} = 14.6$ kHz; $V_{24} = 2.5$ V	2
VCO-voltage PLL	V_{27}	2	3	4	V	$f_{24} = 15.625$ kHz; $V_{24} = 2.5$ V	2
VCO-voltage PLL	V_{27}			4.7	V	$f_{24} = 16.6$ kHz; $V_{24} = 2.5$ V	2
VCO-voltage PLL	V_{27}	1.3			V	$f_{24} = 58.4$ kHz; $V_{24} = 2.5$ V 00,08, *H-pulse*	2
VCO-voltage PLL	V_{27}			4.7	V	$f_{24} = 66.4$ kHz; $V_{24} = 2.5$ V 00,08, *H-pulse*	2
VCO-voltage PLL	V_{27}	2	3	4	V	00,08 - 04.81 *H-pulse; quartz cont. function*	4

$$V_{\text{Filter gain}} = \frac{\sqrt{(V_{25} - V_{25}{}^*)^2 + (V_{26} - V_{26}{}^*)^2}}{V_5} \quad \begin{array}{l} V_{25} \text{ or } V_{26} \text{ when } V_5 = 0 \\ V_{25}{}^* \text{ or } V_{26}{}^* \text{ when } V_5 = 100 \text{ mVpp}; m = 50\% \end{array}$$

Parameter	Symbol	min.	typ.	max.	Unit	Test Condition	Test Circuit
ID-filter gain	$V_{KT\ Filter}$	3.4		6.8	V	f_5 = pilot signal dual; I²C-talk: dual	2
ID-filter gain	$V_{KT\ Filter}$	3.4		6.8	V	f_5 = pilot signal stereo; I²C-talk: stereo	2

$V_{5\ test} = V_{25\ (V_5 = 0)} \pm \Delta V_{25}$; $V_{26\ test} = V_{26\ (V_5 = 0)} \pm \Delta V_{26}$

Characteristics (cont'd)

Parameter	Symbol	Limit Values			Unit	Test Condition	Test Circuit
		min.	typ.	max.			
Detection threshold	ΔV_{25}	900			mV	I²C-talk: stereo or dual	3
Detection threshold	$-\Delta V_{25}$	900			mV	I²C-talk: stereo or dual	3
Detection threshold	ΔV_{26}	900			mV	I²C-talk: stereo or dual	3
Detection threshold	$-\Delta V_{26}$	900			mV	I²C-talk: stereo or dual	3
Mono threshold	ΔV_{25}	0		100	mV	I²C-talk: mono	3
Mono threshold	$-\Delta V_{25}$	0		100	mV	I²C-talk: mono	3
Mono threshold	ΔV_{26}	0		100	mV	I²C-talk: mono	3
Mono threshold	$-\Delta V_{26}$	0		100	mV	I²C-talk: mono	3
Response of detection	t_{det}	1/4		1/2	t_{MPX}	I²C-talk: stereo or dual; $\pm\Delta V_{25}$ = 1 V	3
Response of detection	t_{det}	1/4		1/2	t_{MPX}	I²C-talk: stereo or dual; $\pm\Delta V_{26}$ = 1 V	3

Characteristics (cont'd)

Parameter	Symbol	Limit Values			Unit	Test Condition	Test Circuit
		min.	typ.	max.			
Switching threshold f_{REF}-input	$V_{H in L}$	0		1.5	V		2
Switching threshold f_{REF}-input	$V_{H in L}$	3.5		V_{21}	V		2
Amplitude crystal oscillator	V_{24}		0.3		Vpp	$f_0 = 4.00000$ MHz Serial resonance	4
Ext. 1- or 4 MHz-clock signal	V_{24}		2		Vpp		3
Crystal current	I_C	0.29	0.35	0.42	mArms	$R_C = 40 \ \Omega$	
Multiplexer clock	t_{MPX}		2.17		s	09,08, *MPX = 2 s*	
Multiplexer clock	t_{MPX}		4.34		s	09,48, *MPX = 4 s*	
Multiplexer clock	t_{MPX}		8.68		s	09,88, *MPX = 8 s*	
Design-Related Data							
Filter output resistance	$R_{25,26}$	110			kΩ		
f_{REF}-input resistance	R_{24}	800			Ω		
Input impedance crystal oscillator	Z_{24}	− 600	− 500	− 400	Ω		
Crystal serial resistance	R_{C1}			100	Ω	$P_{tot} = 1 \ \mu W$, fundamental	
Crystal serial resistance	R_{C3}	300			Ω	$P_{tot} = 1 \ \mu W$ 3rd harmonic	
Spurious wave spacing (fundamental wave to harmonic and nonharmonic signals)		20			dB	$P_{tot} = 1 \ \mu W$ $f < 15$ MHz	

Characteristics (cont'd)

Parameter	Symbol	Limit Values			Unit	Test Condition
		min.	typ.	max.		
I²C Bus (SCL, SDA)						
SCL, SDA edges						
Rise time	t_R			1	µs	
Fall time	t_F			300	ns	
Shift register clock pulse SCL						
Frequency	f_{SCL}	0		100	kHz	
H-pulse width	t_{HIGH}	4			µs	
L-pulse width	t_{LOW}	4			µs	
Start						
Set-up time	t_{SUSTA}	4			µs	
Hold time	t_{HDSTA}	4			µs	
Stop						
Set-up time	t_{SUDAT}	1			µs	
Bus free time	t_{HDDAT}	1			µs	
Data transfer						
Set-up time	t_{SUDAT}	1			µs	
Hold time	t_{HDDAT}	600			ns	
Input SCL, SDA						
Input voltage	V_{QH}	3		5.5	V	
	V_{QL}			1.5	V	
Input current	V_{QH}			50	µA	
	V_{QL}			100	µA	
Output SDA (Open collector)						
Output voltage	V_{QH}	5.4			V	$R_L = 2.5$ kΩ
	V_{QL}			0.4	V	$I_{QL} = 3$ mA

Test Circuit 1

UES03418
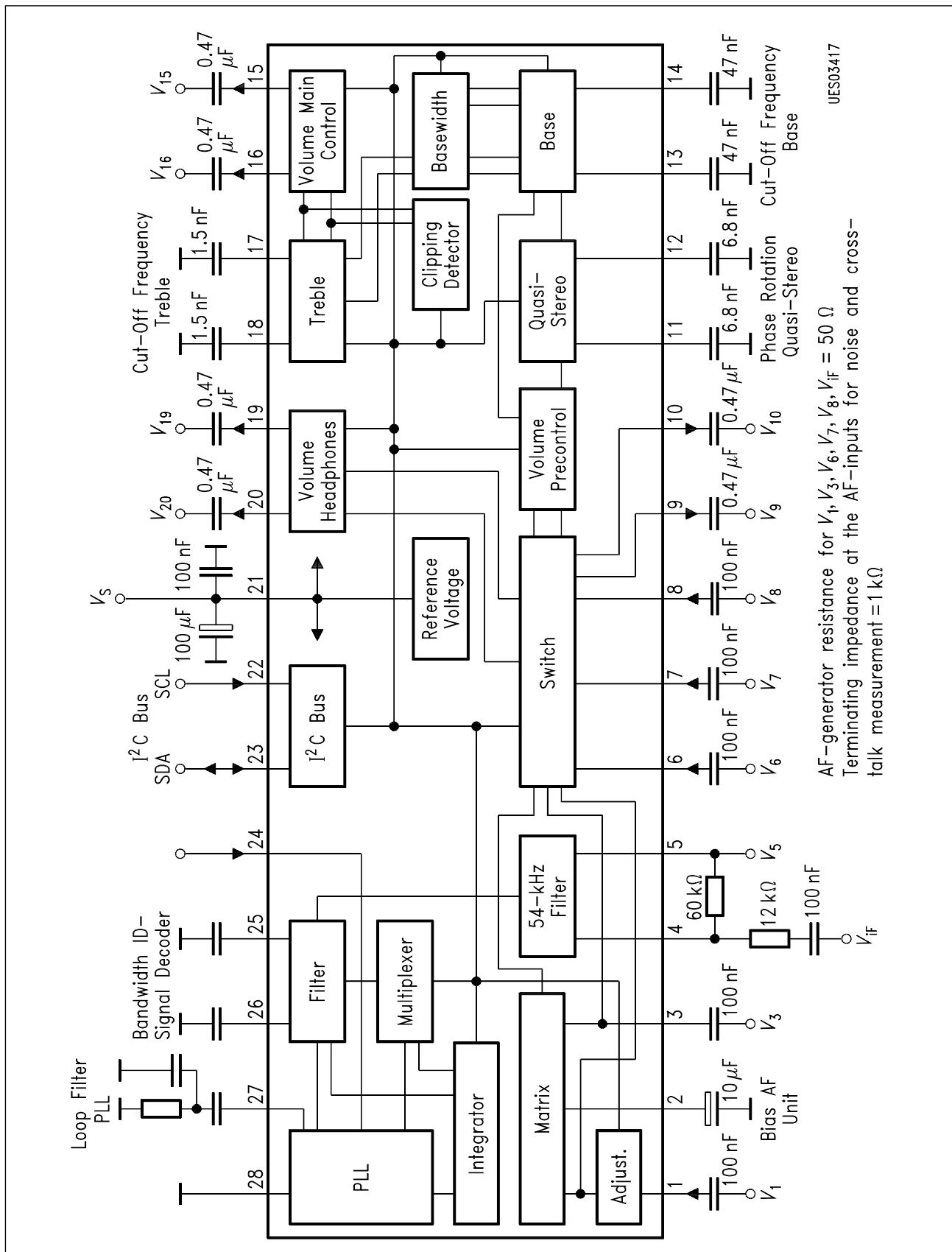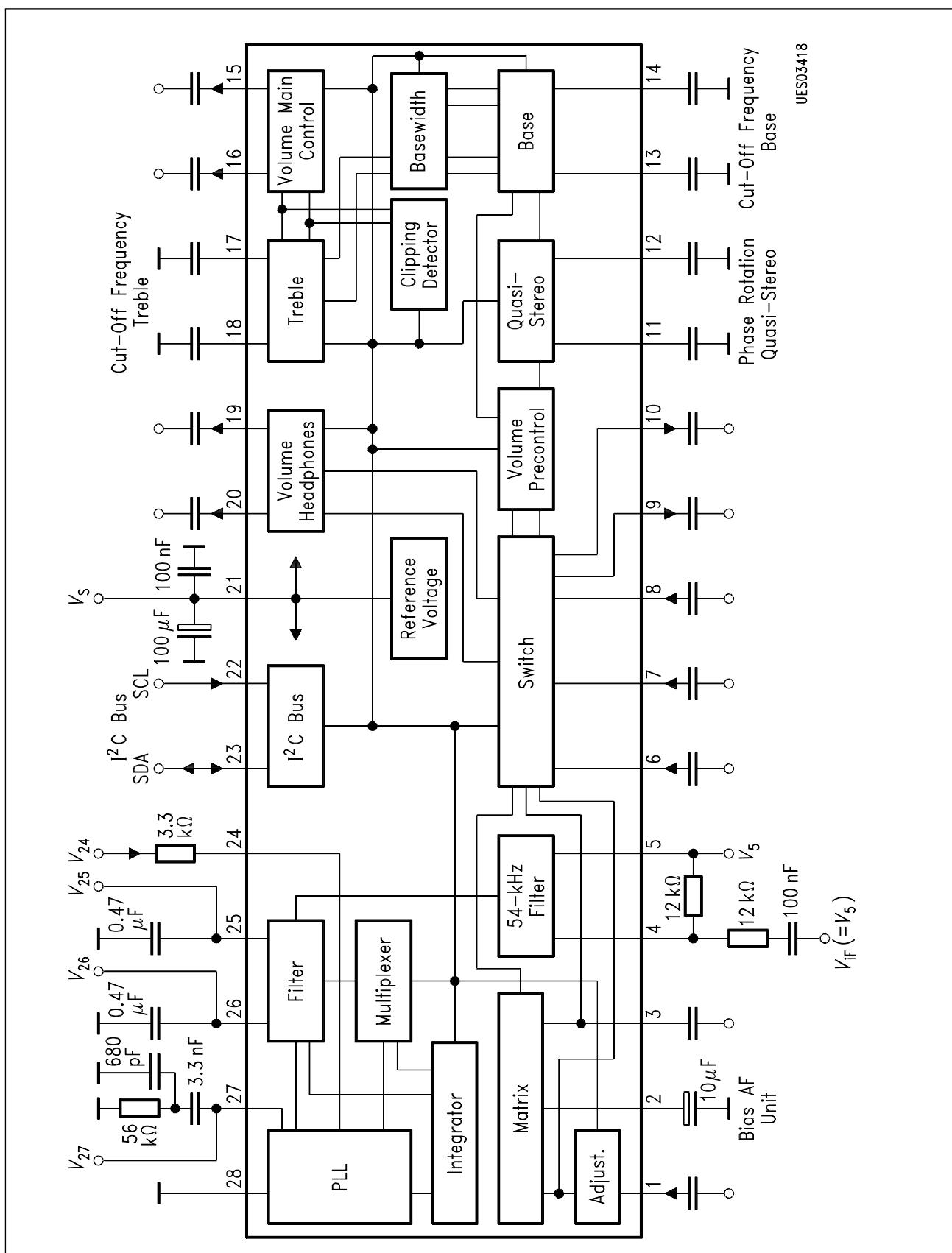
Test Circuit 2

Test Circuit 3

UES03420

Test Circuit 4

UES03421

Application Circuit 1

UES03422

Application Circuit 2

UES03423

Cut-Off Frequency Base

47 nF

47 nF

6.8 nF

6.8 nF

Phase Rotation Quasi-Stereo

0.47 μF

0.47 μF

SCART Output Mono Mono Sound 1 Sound 2 Left Right

100 nF

100 nF

SCART Input Right Sound 2

100 nF

SCART Input Left Sound 1 Sound 2

100 nF

AF Input L Standard

AF Loudspeakers Right

AF Loudspeakers Left

Cut-Off Frequency Treble

AF Headphones Right

AF Headphones Left

0.47 μF

0.47 μF

1.5 nF

1.5 nF

0.47 μF

0.7 μF

V_S

10 μF

I²C Bus SCL

I²C Bus SDA

4-MHz Quarz

27 pF

1 μF

1 μF

1 μF

Bandwidth ID-Signal Decoder

Loop Filter PLL

680 pF

56 kΩ

3.3 nF

Volume Main Control

Basewidth

Base

Clipping Detector

Treble

Quasi-Stereo

Volume Headphones

Volume Precontrol

Reference Voltage

Switch

I²C Bus

PLL

Integrator

Multiplexer

Filter

Matrix

Adjust.

54-kHz Filter

2.2 nF

3.9 mH

54-kHz Filter

10 nF

12 kΩ

1 nF

AF Input Sound 2, Right

5.6 kΩ

100 nF

10 μF

Bias AF Unit

100 nF

10 nF

5.6 kΩ

AF Input Mono, Sound 1 (L+R)/2, Left

Application Circuit 3

UED03424

I²C Bus Timing Diagram

t_{SUSTA}	Setup time (start)
t_{HDSTA}	Hold time (start)
t_{HIGH}	H-pulse width (clock)
t_{LOW}	L-pulse width (clock)
t_{SUDAT}	Setup time (data transfer)
t_{HDDAT}	Hold time (data transfer)
t_{SUSTO}	Setup time (stop)
t_{BUF}	Bus free time
t_F	Fall time
t_R	Rise time

All times referred to V_{IH} and V_{IL} values.

Package Outlines

Plastic Package, P-DIP-28-1
(Plastic Dual In-Line Package)
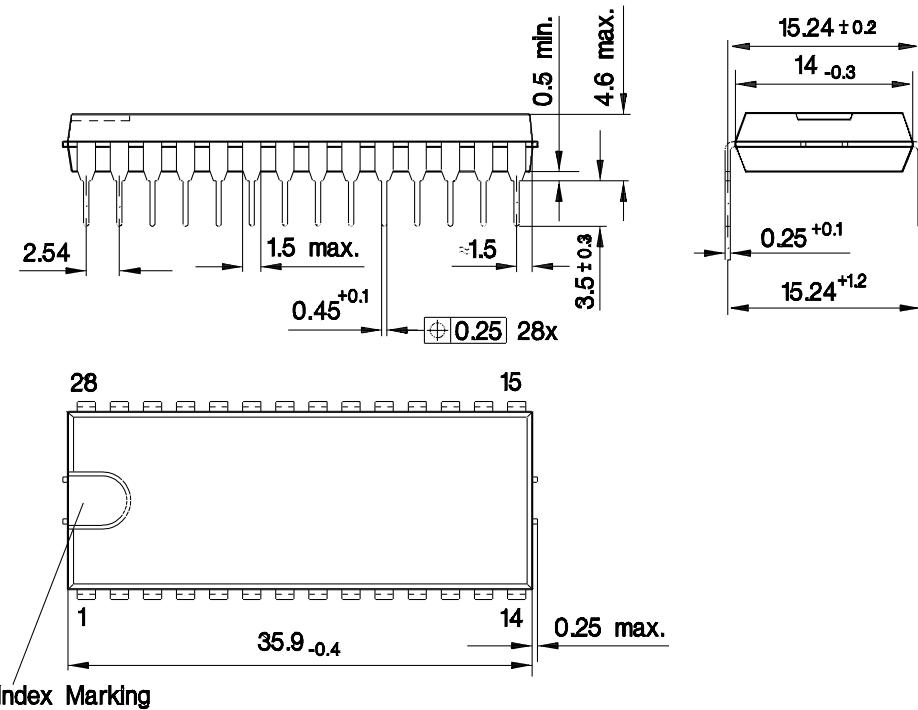
GPD05037

Plastic Package, P-DSO-28.350 (SMD)
(Plastic Dual Small Outline)

0.18 ± 0.08
(2.3)
2.54 max.

1.27

0.41 +0.07 -0.05

1)

⊕ 0.254 Ⓜ 28x

⌓ 0.1

8.9 -0.3 1)

0.2 +0.12 -0.05

8° max.

0.8 ± 0.25

12 +0.12 -0.24

28   15

1   14

18.3 -0.3 1)

Index Marking
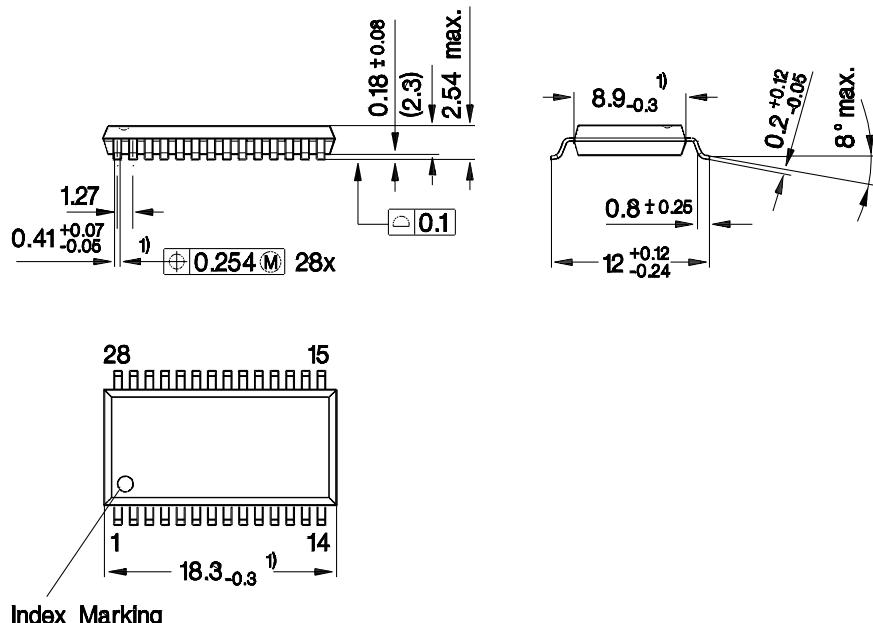
1) Does not include plastic or metal protrusion of 0.25 max. per side

2) Does not include dambar protrusion

GPS05182

Sorts of Packing
Package outlines for tubes, trays etc. are contained in our
Data Book "Package Information"

SMD = Surface Mounted Device

Dimensions in mm